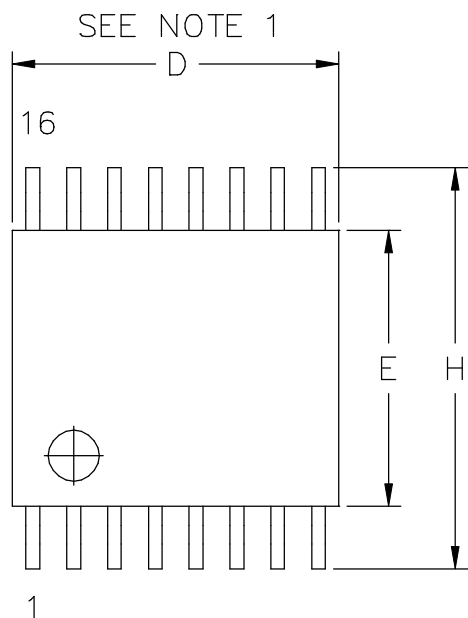
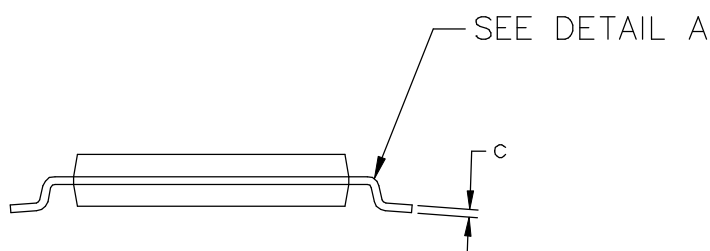
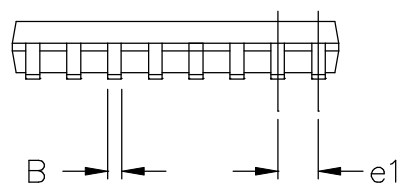


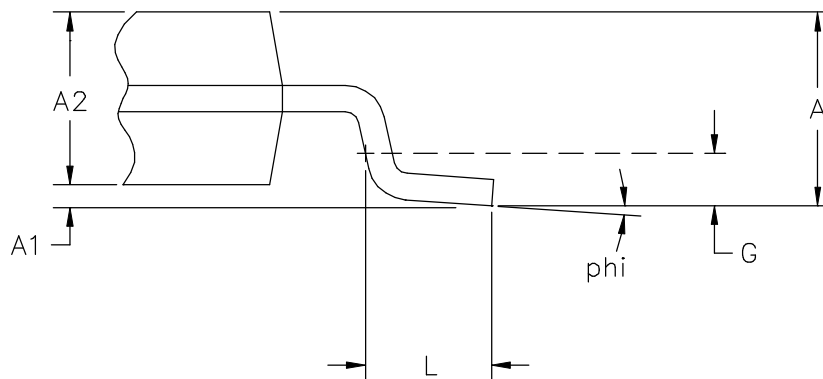


NOTES:

1. DIMENSION "D" DOES NOT INCLUDE MOLD MISMATCH, FLASH, OR PROTRUSIONS.



DIM	MIN	MAX
A	—	1.10
A1	0.05	—
A2	0.75	1.05
B	0.18	0.30
c	0.09	0.18
D	4.90	5.10
E	4.40 NOM	
e1	0.65 BSC	
G	0.25 REF	
H	6.25	6.55
L	0.50	0.70
phi	0°	8°



DETAIL A

DIMENSIONS ARE IN MILLIMETERS

SIGNATURE		DATE		 Dallas Semiconductor			
DOC. CONTROL:							
ENGR. MGR:				TITLE MARKETING OUTLINE, 16 LD. TSSOP, 4.4 MM BODY			
MFG. ENGR:							
CHECKED BY:							
DRAWN BY:				SIZE A	FSCM NO	PART NO.	REV A
DO NOT SCALE DWG.				SCALE N/A		SHEET 1 OF 1	